



## IR Receiver Modules for Remote Control Systems



22911

### LINKS TO ADDITIONAL RESOURCES



Product Page



Marking



Holders



Bends and Cuts

### DESCRIPTION

This IR receiver series is optimized for short burst remote control systems in different environments. The customer can choose between different IC settings (AGC variants), to find the optimum solution for his application. The higher the AGC, the better noise is suppressed, but the lower the code compatibility.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding. These components have not been qualified to automotive specifications.

### FEATURES

- Individual IC settings to reach maximum performance
- Immunity against noise (lamps, LCD TV, Wi-Fi)
- Low supply current
- Photo detector and preamplifier in one package
- Supply voltage: 2.0 V to 5.5 V
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

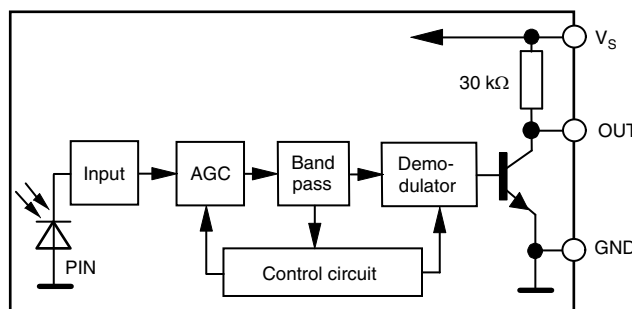
### DESIGN SUPPORT TOOLS

- [3D models](#)
- [Window size calculator](#)

### APPLICATIONS

- Infrared remote control systems

### BLOCK DIAGRAM



16833-22

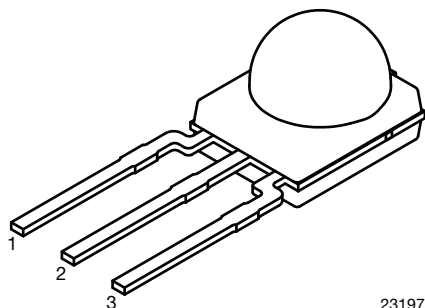


## TSOP531..DF1P, TSOP533..DF1P, TSOP535..DF1P

Vishay Semiconductors

## MECHANICAL DATA

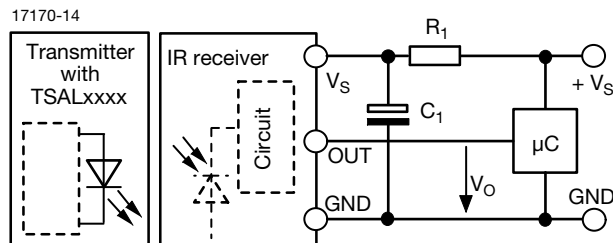
## Pinning for TSOP53...DF1P:

1 = OUT, 2 = GND, 3 =  $V_S$ 

## ORDERING CODE

TSOP53...DF1P - 1100 pieces in tape and reel

## APPLICATION CIRCUIT



$R_1$  and  $C_1$  recommended in case there are strong ripple or spikes on the supply line.

## PARTS TABLE

AGC		LEGACY, FOR SHORT BURSTS (AGC1)	FOR SHORT BURSTS, NOISY ENVIRONMENTS (AGC3)	FOR SHORT BURSTS, VERY NOISY ENVIRONMENTS (AGC5)
Carrier frequency	30 kHz	TSOP53130DF1P	TSOP53330DF1P	TSOP53530DF1P
	33 kHz	TSOP53133DF1P	TSOP53333DF1P	TSOP53533DF1P
	36 kHz	TSOP53136DF1P	TSOP53336DF1P <sup>(1)(2)</sup>	TSOP53536DF1P
	38 kHz	TSOP53138DF1P	TSOP53338DF1P <sup>(3)(5)</sup>	TSOP53538DF1P
	40 kHz	TSOP53140DF1P	TSOP53340DF1P	TSOP53540DF1P
	56 kHz	TSOP53156DF1P	TSOP53356DF1P <sup>(4)</sup>	TSOP53556DF1P
Package		Minimold		
Pinning		1 = OUT, 2 = GND, 3 = $V_S$		
Dimensions (mm)		5.4 W x 6.35 H x 4.9 D		
Mounting		SMD		
Application		Remote control		
Best choice for		<sup>(1)</sup> MCIR <sup>(2)</sup> RCMM <sup>(3)</sup> RECS-80 Code <sup>(4)</sup> r-map <sup>(5)</sup> XMP		
Special options		<ul style="list-style-type: none"> <li>Narrow optical filter: <a href="http://www.vishay.com/doc?81590">www.vishay.com/doc?81590</a></li> <li>Wide optical filter: <a href="http://www.vishay.com/doc?82726">www.vishay.com/doc?82726</a></li> </ul>		

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		$V_S$	-0.3 to +6	V
Supply current		$I_S$	5	mA
Output voltage		$V_O$	-0.3 to 5.5	V
Voltage at output to supply		$V_S - V_O$	-0.3 to ( $V_S + 0.3$ )	V
Output current		$I_O$	5	mA
Junction temperature		$T_j$	100	°C
Storage temperature range		$T_{stg}$	-25 to +85	°C
Operating temperature range		$T_{amb}$	-25 to +85	°C
Power consumption	$T_{amb} \leq 85^\circ\text{C}$	$P_{tot}$	10	mW
Soldering temperature	$t \leq 10\text{ s, } 1\text{ mm from case}$	$T_{sd}$	260	°C

## Note

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



ELECTRICAL AND OPTICAL CHARACTERISTICS ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current	$E_v = 0, V_S = 3.3\text{ V}$	$I_{SD}$	0.25	0.35	0.45	mA
	$E_v = 40\text{ klx}$ , sunlight	$I_{SH}$	-	0.45	-	mA
Supply voltage		$V_S$	2.0	-	5.5	V
Transmission distance	$E_v = 0$ , test signal see Fig. 1, IR diode TSAL6200, $I_F = 50\text{ mA}$	$d$	-	24	-	m
Output voltage low	$I_{OSL} = 0.5\text{ mA}$ , $E_e = 0.7\text{ mW/m}^2$ , test signal see Fig. 1	$V_{OSL}$	-	-	100	mV
Minimum irradiance	Test signal: RC5 code	$E_{e\text{ min.}}$	-	0.12	0.25	$\text{mW/m}^2$
	Test signal: XMP code	$E_{e\text{ min.}}$	-	0.2	0.4	$\text{mW/m}^2$
Maximum irradiance	$t_{pi} - 3/f_o < t_{po} < t_{pi} + 3.5/f_o$ , test signal see Fig. 1	$E_{e\text{ max.}}$	50	-	-	$\text{W/m}^2$
Directivity	Angle of half transmission distance	$\Phi_{1/2}$	-	$\pm 45$	-	deg

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)

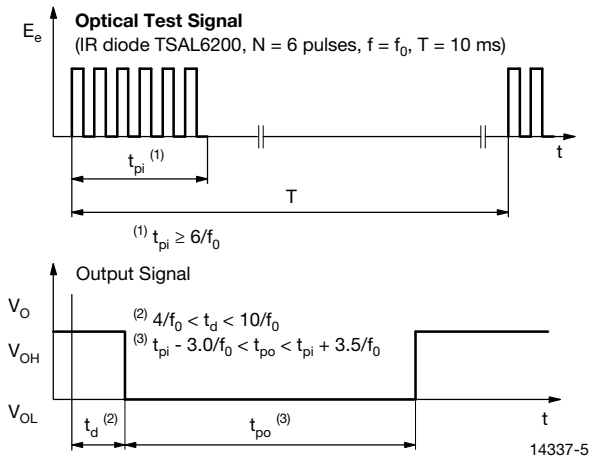


Fig. 1 - Output Active Low

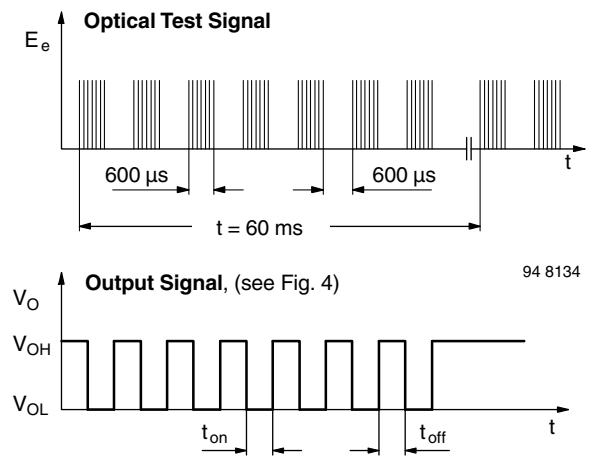


Fig. 3 - Output Function

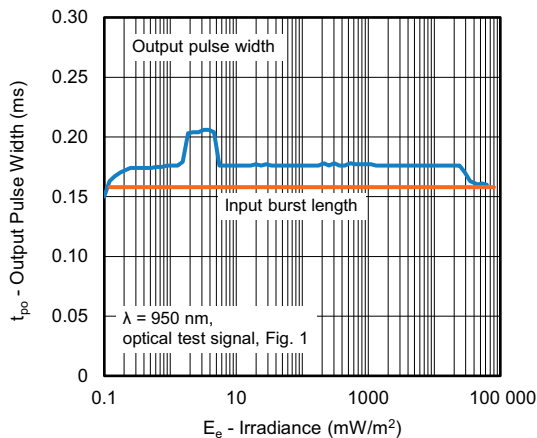


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

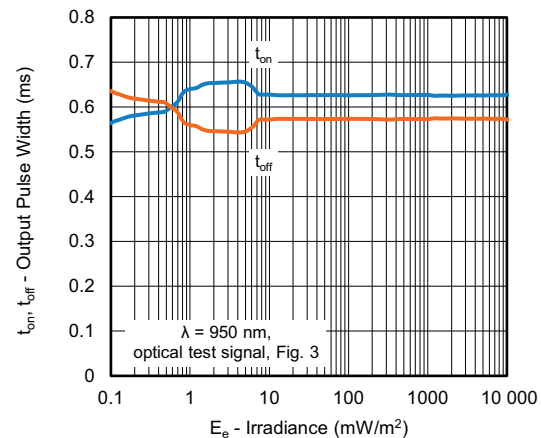


Fig. 4 - Output Pulse Diagram

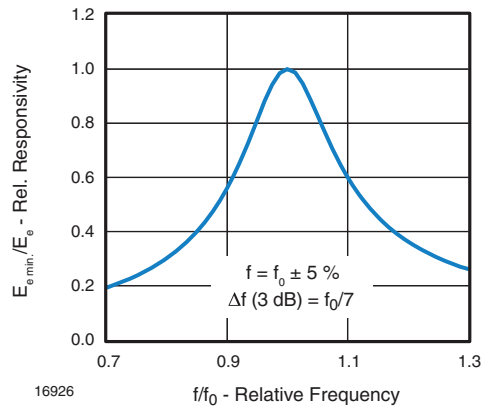


Fig. 5 - Frequency Dependence of Responsivity

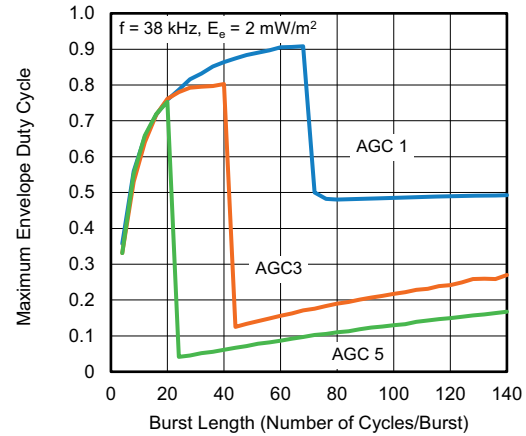


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

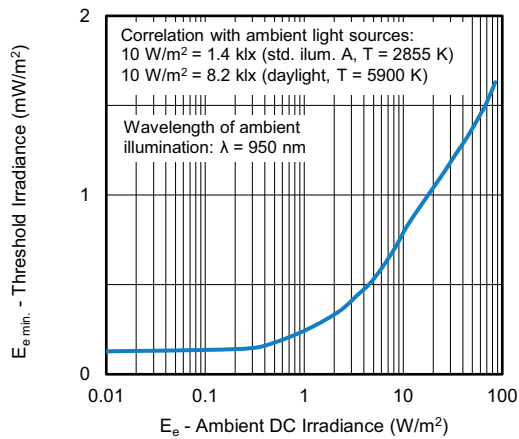


Fig. 6 - Sensitivity in Bright Ambient

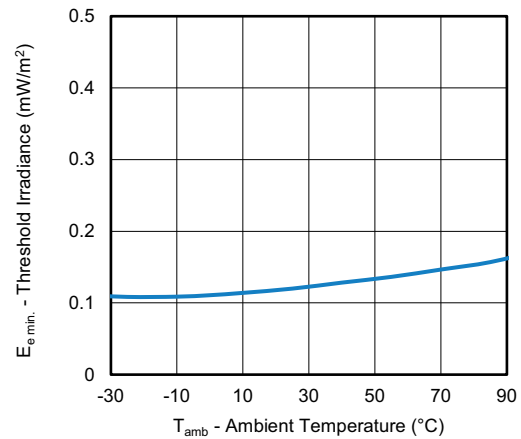


Fig. 9 - Sensitivity vs. Ambient Temperature

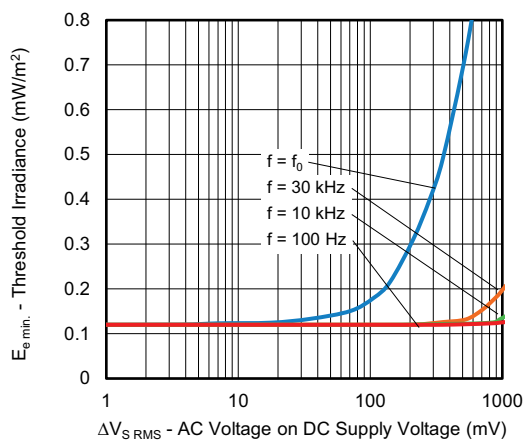


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

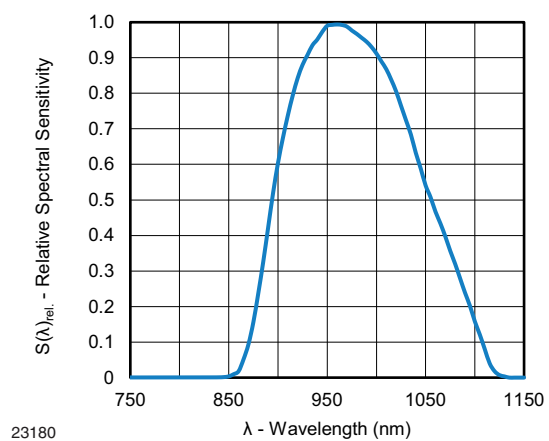


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

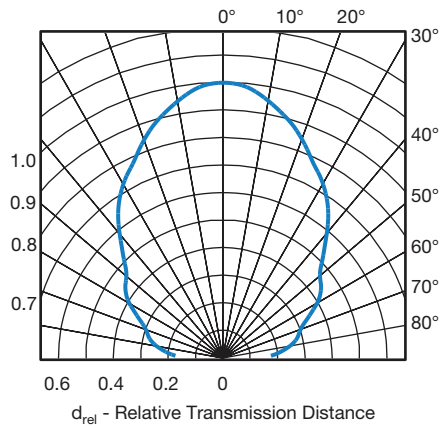


Fig. 11 - Horizontal Directivity

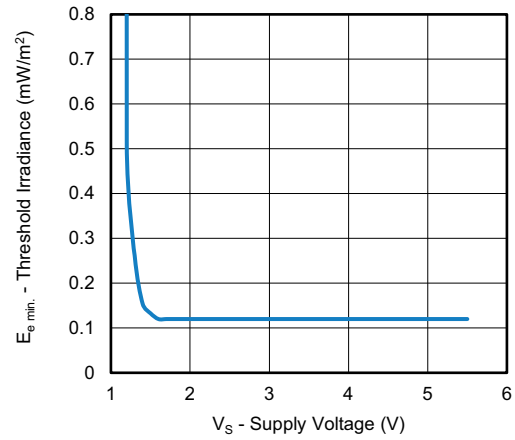


Fig. 12 - Sensitivity vs. Supply Voltage



### SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14).
- 2.4 GHz and 5 GHz Wi-Fi

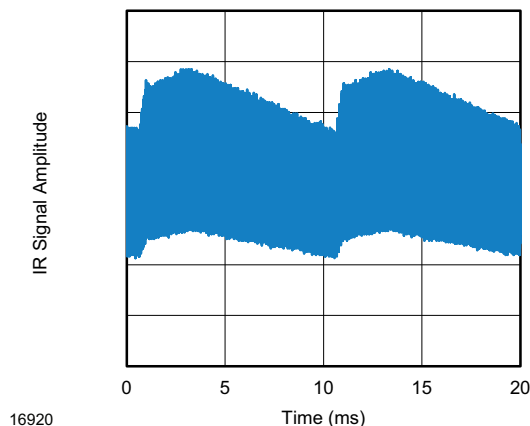


Fig. 13 - IR Disturbance from Fluorescent Lamp With Low Modulation

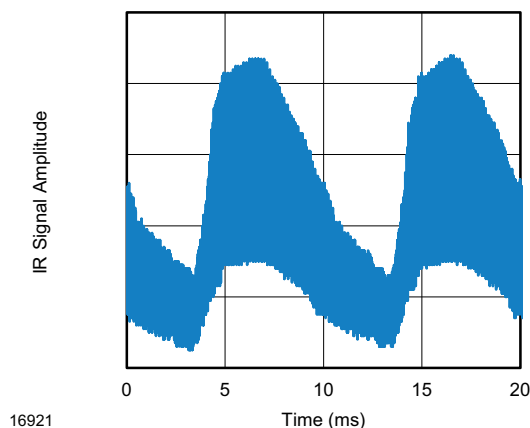


Fig. 14 - IR Disturbance from Fluorescent Lamp With High Modulation

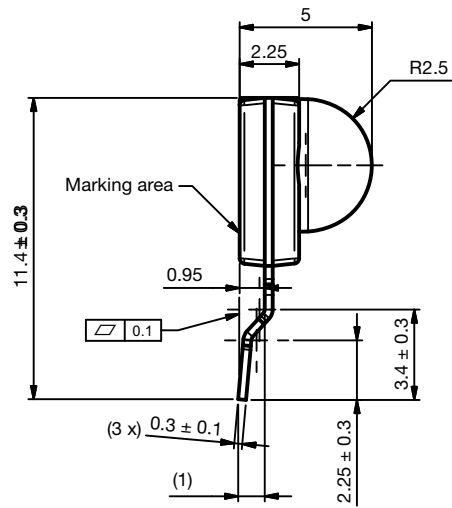
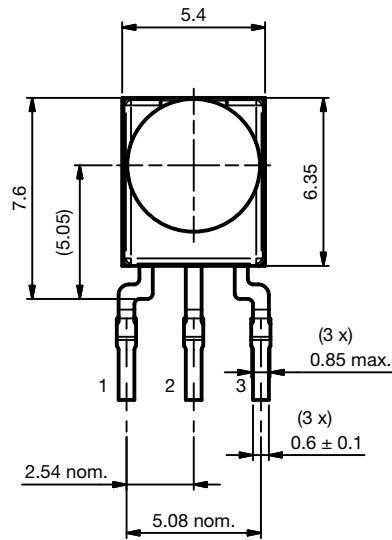
	TSOP531..DF1P	TSOP533..DF1P	TSOP535..DF1P
Minimum burst length	6 cycles/burst	6 cycles/burst	6 cycles/burst
After each burst of length A gap time is required of	6 to 68 cycles ≥ 6 cycles	6 to 40 cycles ≥ 7 cycles	6 to 20 cycles ≥ 7 cycles
For bursts greater than a minimum gap time in the data stream is needed of	68 cycles > 1 x burst length	40 cycles > 6 x burst length	20 cycles > 10 x burst length
Maximum number of continuous short bursts/second	2500	2500	2500
RCMM code	Yes	Preferred	Yes
XMP code	Yes	Preferred	Yes
r-map code	Yes	Preferred	Yes
RECS-80 code	Yes	Preferred	Yes
Suppression of interference from fluorescent lamps	Mild disturbance patterns are suppressed (example: signal pattern of Fig. 13)	Complex disturbance patterns are suppressed (example: signal pattern of Fig. 14)	Critical disturbance patterns are suppressed, e.g. highly dimmed LCDs

#### Note

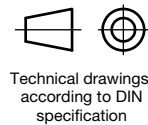
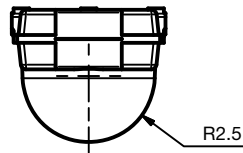
- For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP532..DF1P, TSOP534..DF1P



**PACKAGE DIMENSIONS** in millimeters

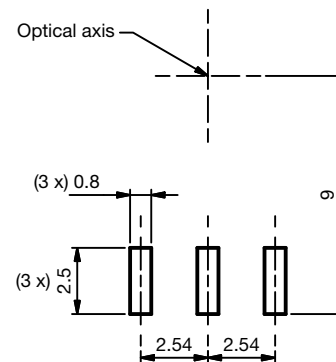


Not indicated tolerances  $\pm 0.2$



Technical drawings  
according to DIN  
specification

Proposed pad layout  
from component side  
(for reference only)



Drawing-No.: 6.550-5343.01-4  
Issue: 2; 02.07.19



## ASSEMBLY INSTRUCTIONS

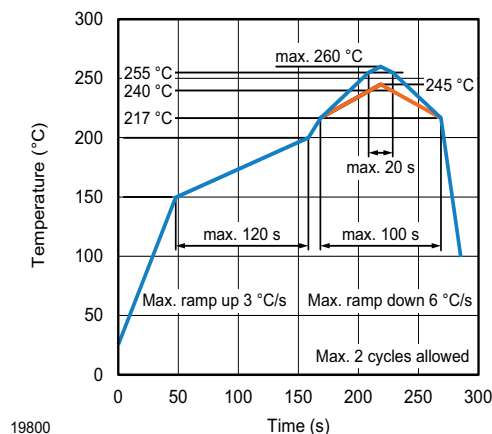
### Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

### Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

## VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE





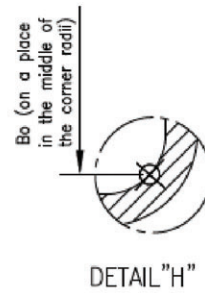
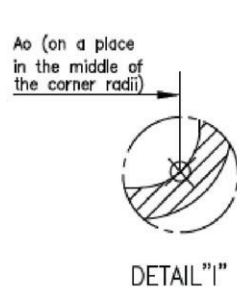
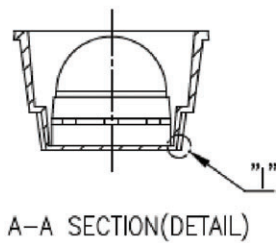
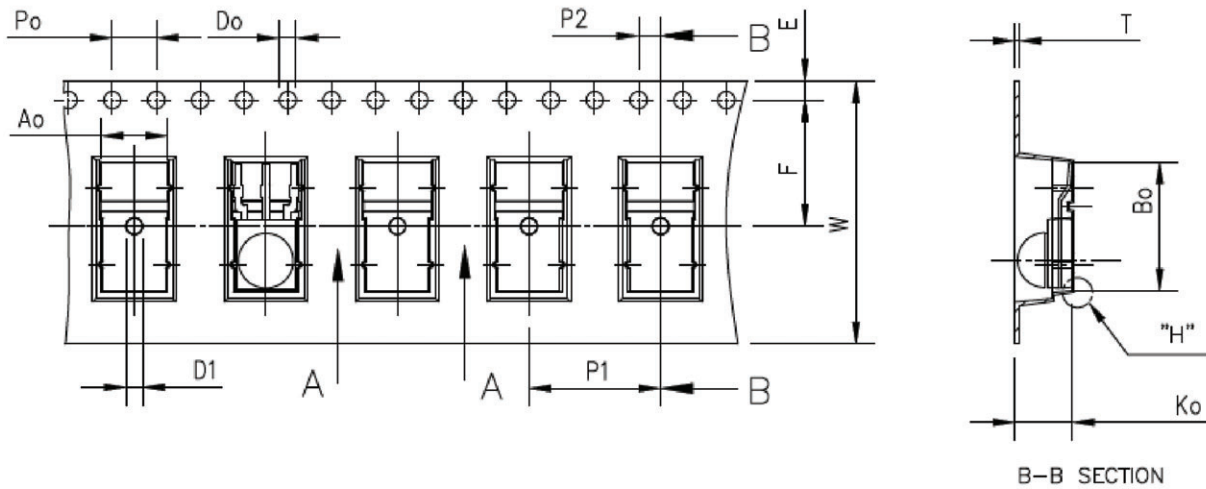


www.vishay.com

# TSOP531..DF1P, TSOP533..DF1P, TSOP535..DF1P

Vishay Semiconductors

## PACKAGING DIMENSIONS in millimeters

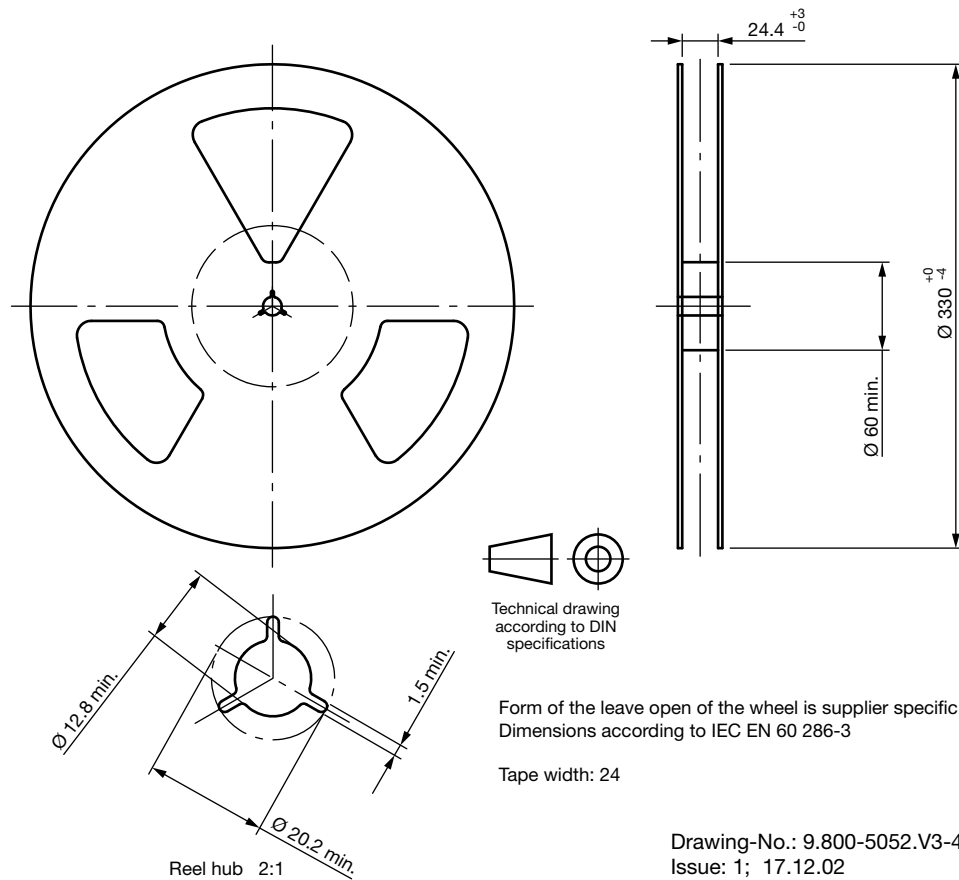


Drawing-No.: 9.700-5399.01-4  
Issue: 2; 29.06.18

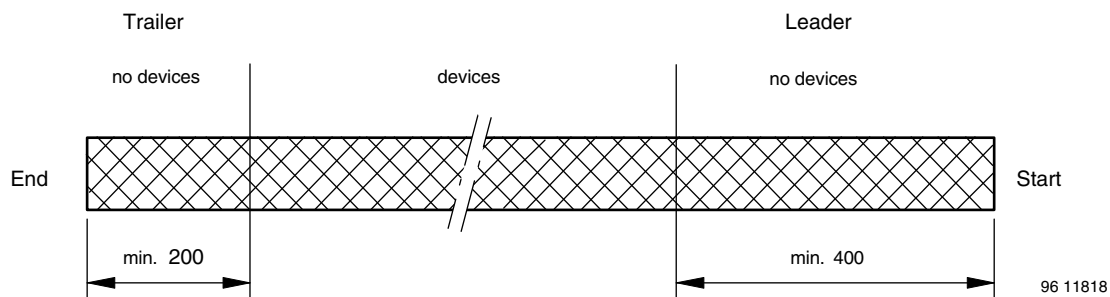
Item	$A_0$	$B_0$	$K_0$	$P_0$	$P_1$	$P_2$	$T$
Dimensions	$6.08 \pm 0.10$	$11.75 \pm 0.10$	$5.25 \pm 0.10$	$4.0 \pm 0.10$	$12.0 \pm 0.10$	$2.0 \pm 0.10$	$0.40 \pm 0.05$
Item	$E$	$F$	$D_0$	$D_1$	$W$	$10P_0$	
Dimensions	$1.75 \pm 0.10$	$11.50 \pm 0.10$	$1.55 \pm 0.05$	1.5 min.	$24.0 +0.30 / -0.10$	$40.0 \pm 0.20$	



**REEL DIMENSIONS** in millimeters



**LEADER AND TRAILER DIMENSIONS** in millimeters



**COVER TAPE PEEL STRENGTH**

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min.  $\pm$  10 mm/min.

165° to 180° peel angle



## ORDERING INFORMATION



## Note

- d = "digit", please consult the list of available series on the previous page to create a valid part number

## Example: TSOP53138DF1P

## PACKAGING QUANTITY

- 1100 pieces per reel
- 1 reel per box

## LABEL

## Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17



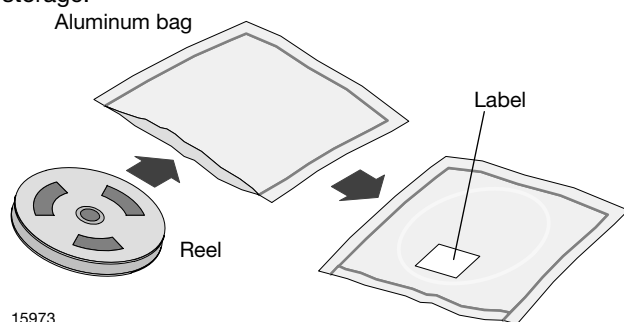
www.vishay.com

# TSOP531..DF1P, TSOP533..DF1P, TSOP535..DF1P

Vishay Semiconductors

## DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



## FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

## RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

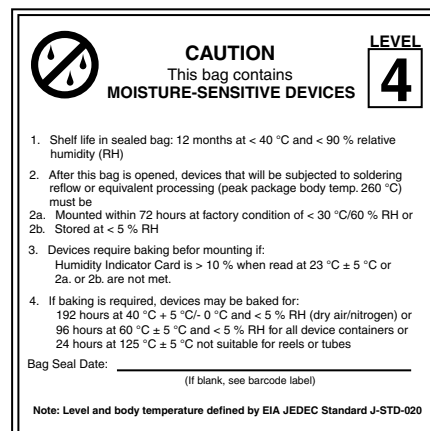
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



22522

EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

## ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

## VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22645



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.